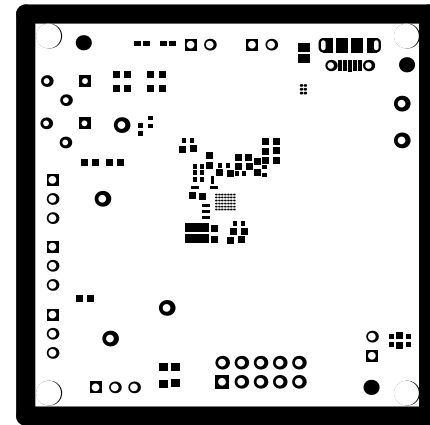
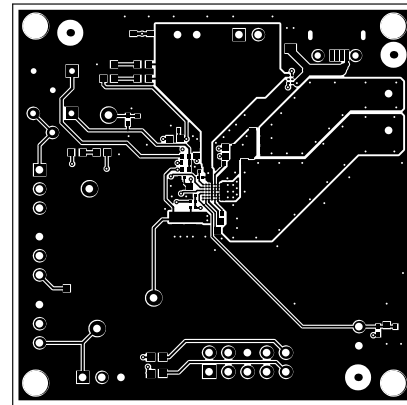


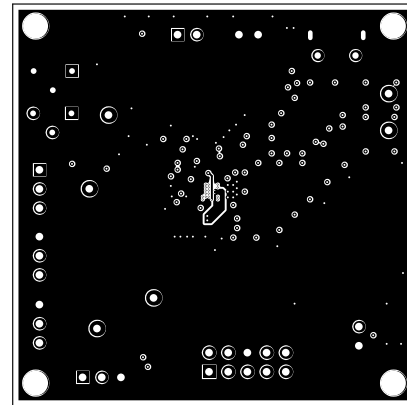
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 3/25/2014 8:51:30 AM	TEXAS INSTRUMENTS	



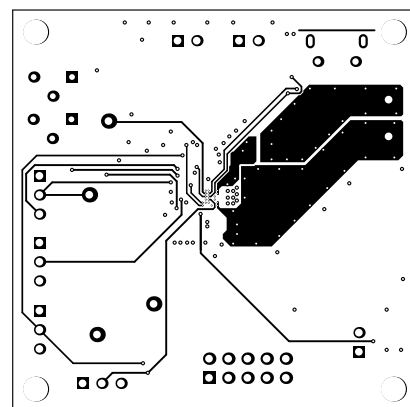
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 3/25/2014 8:51:31 AM	TEXAS INSTRUMENTS	



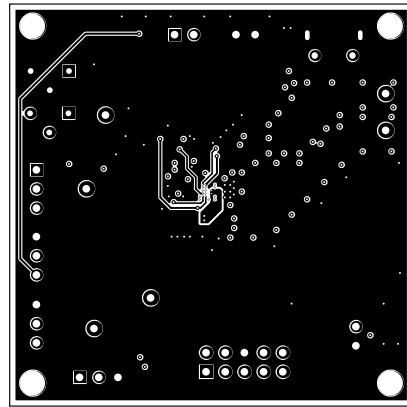
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 3/25/2014 8:51:31 AM	TEXAS INSTRUMENTS	



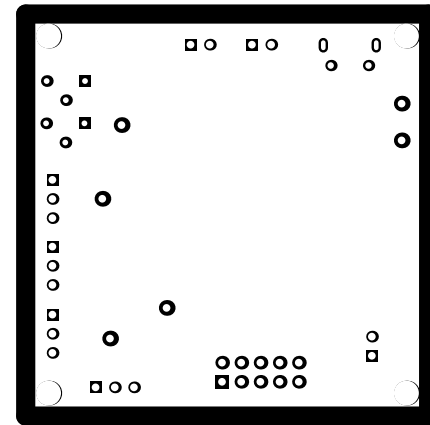
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = MidLayer1			
PLOT NAME = Inner layer 1	GENERATED : 3/25/2014 8:51:32 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = MidLayer2			
PLOT NAME = Inner Layer 2	GENERATED : 3/25/2014 8:51:32 AM	TEXAS INSTRUMENTS	

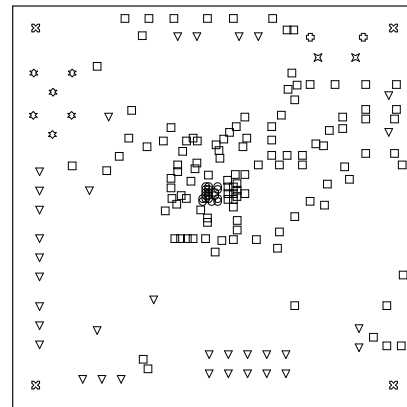


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 3/25/2014 8:51:33 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 3/25/2014 8:51:33 AM	TEXAS INSTRUMENTS	

⚠ 6 MIL VIAS MUST BE PLATED CLOSED.

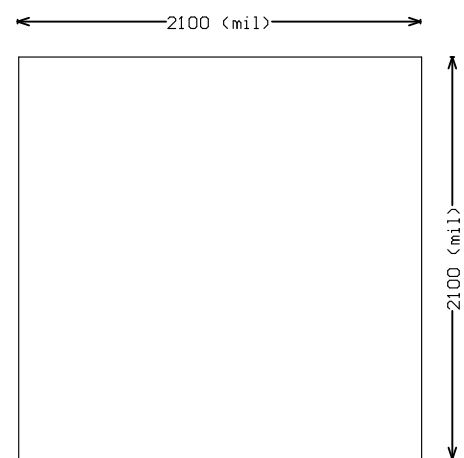


Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Hole Type
○	19	6mil (0.152mm)			PTH	Round
□	117	10mil (0.254mm)			PTH	Round
☆	6	29.528mil (0.75mm)			PTH	Round
×	2	33.465mil (0.85mm)			PTH	Round
▽	34	40mil (1.016mm)			PTH	Round
⊗	4	130mil (3.302mm)			PTH	Round
⊕	2	23.622mil (0.6mm)	51.181mil (1.3mm)	27.559mil (0.7mm)	PTH	Slot
	184 Total					

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.
Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 3/25/2014 8:51:34 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR520	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 3/25/2014 8:51:34 AM	TEXAS INSTRUMENTS	

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